



SPECIFICATION

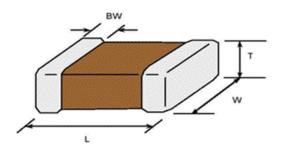
(Reference sheet)

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N :
 Description :
- CL10C910JB8NCNC CAP, 91pF, 50V, ± 5%, C0G, 0603

A. Samsung Part Number

① SeriesSamsung Multi-layer Ceramic Capacitor② Size0603 (inch code)L: 1.60 ± 0.10 mmW: 0.80 ± 0.10 mm	
	nm
③ Dielectric COG ⑧ Inner electrode Ni ④ Capacitance 91 pF Termination Cu	
⑤ Capacitance ± 5% Plating Sn 100% tolerance ⑨ Product High-Q ⑥ Rated Voltage 50 V ⑩ Special Reserved for ⑦ Thickness 0.80 ± 0.10 mm ⑪ Packaging Cardboard T	

B. Structure and dimension



Samsung P/N	Dimension(mm)			
(Lead Free)	L	W	Т	BW
CL10C910JB8NCNC	1.60 ± 0.10	0.80 ± 0.10	0.80 ± 0.10	0.30 ± 0.20

C. Samsung Reliability Test and Judgement condition

	Performance	Test condition	
Capacitance	Within specified tolerance	1 ^{Mbz} ±10% / 0.5~5Vrms	
Q	1,000 min		
Insulation	10,000Mohm or 500Mohm× <i>μ</i> F	Rated Voltage 60~120 sec.	
Resistance	Whichever is smaller		
Appearance	No abnormal exterior appearance	Microscop (X10)	
Withstanding	No dielectric breakdown or	300% of the rated voltage	
Voltage	mechanical breakdown		
Temperature	C0G		
Characteristics	(From -55℃ to 125℃, Capacitance change s	hould be within ±30PPM/ິC)	
Adhesive Strength	No peeling shall be occur on the	500g×F, for 10±1 sec.	
of Termination	terminal electrode		
Bending Strength	Capacitance change :	Bending to the limit (1mm)	
	within $\pm 5\%$ or ± 0.5 pF whichever is larger	with 1.0mm/sec.	
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder	
	is to be soldered newly	245±5℃, 3±0.3sec.	
		(preheating : 80~120 ℃ for 10~30sec.)	
Resistance to	Capacitance change :	Solder pot : 270±5°C, 10±1sec.	
Soldering heat	within $\pm 2.5\%$ or $\pm 0.25 \text{ pF}$ whichever is larger		
	Tan δ, IR : initial spec.		
Vibration Test	Capacitance change :	Amplitude : 1.5mm	
	within $\pm 2.5\%$ or $\pm 0.25 \text{pF}$ whichever is larger	From 10Hz to 55Hz (return : 1min.)	
	Tan δ, IR : initial spec.	2hours ´ 3 direction (x, y, z)	
Moisture	Capacitance change :	With rated voltage	
Resistance	within $\pm 7.5\%$ or $\pm 0.75 \text{ pF}$ whichever is larger	40±2℃, 90~95%RH, 500+12/-0hrs	
	Q: 200 min		
	IR : 500Mohm or 25Mohm × μF		
	Whichever is smaller		
High Temperature	Capacitance change :	With 200% of the rated voltage	
Resistance	within $\pm 3\%$ or ± 0.3 pF whichever is larger	Max. operating temperature	
	Q: 350 min	1000+48/-0hrs	
	IR : 1,000Mohm or 50Mohm × μF		
	Whichever is smaller		
Temperature	Capacitance change :	1 cycle condition	
Cycling	within $\pm 2.5\%$ or ± 0.25 pF whichever is larger	Min. operating temperature $\rightarrow 25^{\circ}$	
o young	Tan δ , IR : initial spec.	\rightarrow Max. operating temperature \rightarrow 25 °C	
	,		
		5 cycle test	
		5 cycle test	

* The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 °C, 10sec. Max)

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.

- Disclaimer & Limitation of Use and Application -

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury. We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- Aerospace/Aviation equipment
- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- *④ Military equipment*
- *5* Disaster prevention/crime prevention equipment
- *(c)* Any other applications with the same as or similar complexity or reliability to the applications set forth above.